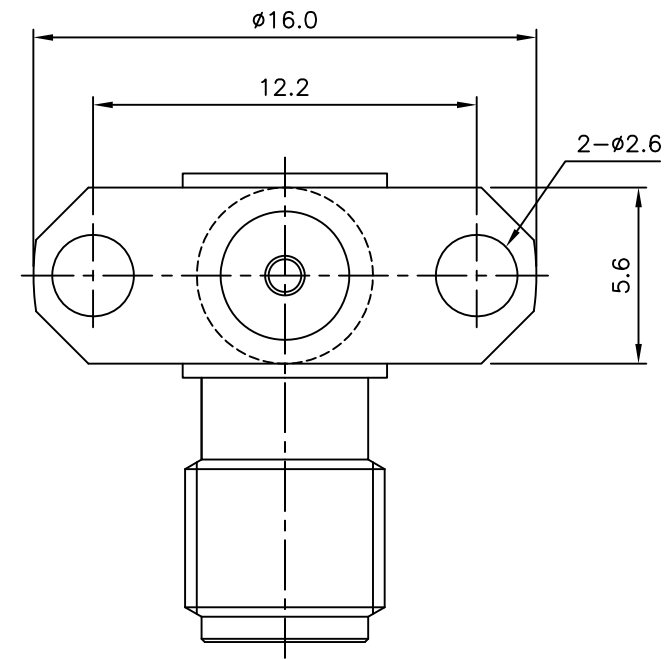
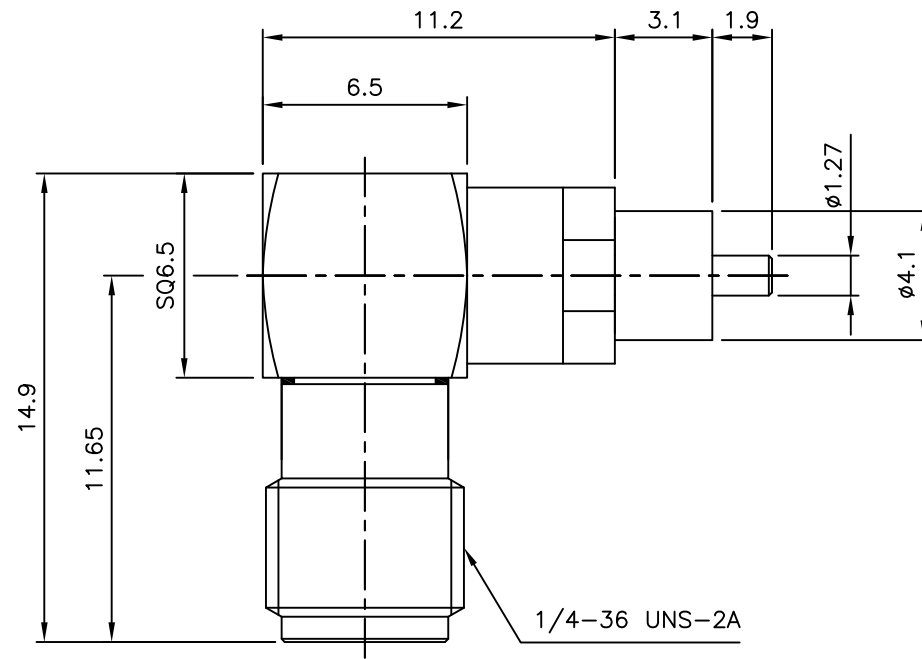
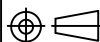


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	S.H.KIM	2022.11.02.



6	COVER	1	MBsBD C3604BD-F	Nickel Plate	DCO00021-5/2	
5	INSULATOR	1	TEFLON		DIN02221-N/2	
4	INSULATOR	1	TEFLON		DIN00112-N/1	
3	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT02898-5/1	
2	CONTACT	1	BeCu C17300	Gold Plate	DCT00151-5/1	
1	1-2 BODY(B)	1	MBsBD C3604BD-F	Nickel Plate	DBB00467-5/1	DBD04383-1/1
	1-1 BODY(A)	1	MBsBD C3604BD-F	Nickel Plate		DBD00223-1/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE	

TOLERANCE	Decimal ±0.2	DATE 2022. 11. 02.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY	S.H.KIM		
MATERIAL		CHECKED BY		TITLE SMA50 SOLDER END JL-2H	
FINISH		DRAWN BY	S.Y.EUN	DWG NO. CN03757-7/2	
SCALE 4/1		UNIT mm		A4	REVISION I R SHEET 1 of 1